



Welcome to [E-XFL.COM](#)

### Understanding **Embedded - FPGAs (Field Programmable Gate Array)**

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

### **Applications of Embedded - FPGAs**

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

#### **Details**

Product Status	Obsolete
Number of LABs/CLBs	768
Number of Logic Elements/Cells	-
Total RAM Bits	-
Number of I/O	130
Number of Gates	12000
Voltage - Supply	2.25V ~ 5.25V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 85°C (TA)
Package / Case	208-BFQFP
Supplier Device Package	208-PQFP (28x28)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/microsemi/a54sx08a-1pq208i">https://www.e-xfl.com/product-detail/microsemi/a54sx08a-1pq208i</a>

## Logic Module Design

The SX-A family architecture is described as a “sea-of-modules” architecture because the entire floor of the device is covered with a grid of logic modules with virtually no chip area lost to interconnect elements or routing. The Actel SX-A family provides two types of logic modules: the register cell (R-cell) and the combinatorial cell (C-cell).

The R-cell contains a flip-flop featuring asynchronous clear, asynchronous preset, and clock enable, using the S0 and S1 lines control signals (Figure 1-2). The R-cell registers feature programmable clock polarity selectable on a register-by-register basis. This provides additional flexibility while allowing mapping of synthesized functions into the SX-A FPGA. The clock source for the R-cell can be chosen from either the hardwired clock, the routed clocks, or internal logic.

The C-cell implements a range of combinatorial functions of up to five inputs (Figure 1-3). Inclusion of the DB input and its associated inverter function allows up to 4,000

different combinatorial functions to be implemented in a single module. An example of the flexibility enabled by the inversion capability is the ability to integrate a 3-input exclusive-OR function into a single C-cell. This facilitates construction of 9-bit parity-tree functions with 1.9 ns propagation delays.

## Module Organization

All C-cell and R-cell logic modules are arranged into horizontal banks called Clusters. There are two types of Clusters: Type 1 contains two C-cells and one R-cell, while Type 2 contains one C-cell and two R-cells.

Clusters are grouped together into SuperClusters (Figure 1-4 on page 1-3). SuperCluster 1 is a two-wide grouping of Type 1 Clusters. SuperCluster 2 is a two-wide group containing one Type 1 Cluster and one Type 2 Cluster. SX-A devices feature more SuperCluster 1 modules than SuperCluster 2 modules because designers typically require significantly more combinatorial logic than flip-flops.

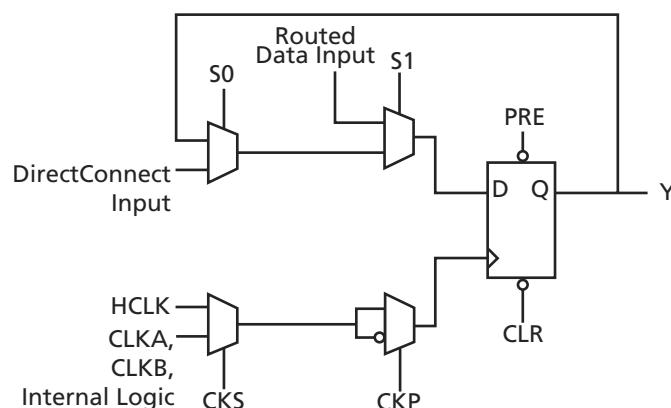


Figure 1-2 • R-Cell

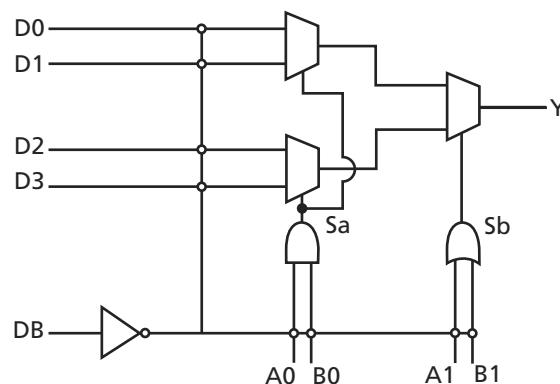


Figure 1-3 • C-Cell

## Other Architectural Features

### Technology

The Actel SX-A family is implemented on a high-voltage, twin-well CMOS process using  $0.22\text{ }\mu\text{/ }0.25\text{ }\mu$  design rules. The metal-to-metal antifuse is comprised of a combination of amorphous silicon and dielectric material with barrier metals and has a programmed ('on' state) resistance of  $25\text{ }\Omega$  with capacitance of  $1.0\text{ fF}$  for low signal impedance.

### Performance

The unique architectural features of the SX-A family enable the devices to operate with internal clock frequencies of 350 MHz, causing very fast execution of even complex logic functions. The SX-A family is an optimal platform upon which to integrate the functionality previously contained in multiple complex programmable logic devices (CPLDs). In addition, designs that previously would have required a gate array to meet performance goals can be integrated into an SX-A device with dramatic improvements in cost and time-to-market. Using timing-driven place-and-route tools, designers can achieve highly deterministic device performance.

### User Security

Reverse engineering is virtually impossible in SX-A devices because it is extremely difficult to distinguish between programmed and unprogrammed antifuses. In addition, since SX-A is a nonvolatile, single-chip solution, there is no configuration bitstream to intercept at device power-up.

The Actel FuseLock advantage ensures that unauthorized users will not be able to read back the contents of an Actel antifuse FPGA. In addition to the inherent strengths of the architecture, special security fuses that prevent internal probing and overwriting are hidden throughout the fabric of the device. They are located where they cannot be accessed or bypassed without destroying access to the rest of the device, making both invasive and more-subtle noninvasive attacks ineffective against Actel antifuse FPGAs.

Look for this symbol to ensure your valuable IP is secure (Figure 1-11).



Figure 1-11 • FuseLock

For more information, refer to Actel's *Implementation of Security in Actel Antifuse FPGAs* application note.

### I/O Modules

For a simplified I/O schematic, refer to Figure 1 in the application note, *Actel eX, SX-A, and RTSX-S I/Os*.

Each user I/O on an SX-A device can be configured as an input, an output, a tristate output, or a bidirectional pin. Mixed I/O standards can be set for individual pins, though this is only allowed with the same voltage as the input. These I/Os, combined with array registers, can achieve clock-to-output-pad timing as fast as 3.8 ns, even without the dedicated I/O registers. In most FPGAs, I/O cells that have embedded latches and flip-flops, requiring instantiation in HDL code; this is a design complication not encountered in SX-A FPGAs. Fast pin-to-pin timing ensures that the device is able to interface with any other device in the system, which in turn enables parallel design of system components and reduces overall design time. All unused I/Os are configured as tristate outputs by the Actel Designer software, for maximum flexibility when designing new boards or migrating existing designs.

SX-A I/Os should be driven by high-speed push-pull devices with a low-resistance pull-up device when being configured as tristate output buffers. If the I/O is driven by a voltage level greater than  $V_{CCA}$  and a fast push-pull device is NOT used, the high-resistance pull-up of the driver and the internal circuitry of the SX-A I/O may create a voltage divider. This voltage divider could pull the input voltage below specification for some devices connected to the driver. A logic '1' may not be correctly presented in this case. For example, if an open drain driver is used with a pull-up resistor to 5 V to provide the logic '1' input, and  $V_{CCA}$  is set to 3.3 V on the SX-A device, the input signal may be pulled down by the SX-A input.

Each I/O module has an available power-up resistor of approximately  $50\text{ k}\Omega$  that can configure the I/O in a known state during power-up. For nominal pull-up and pull-down resistor values, refer to Table 1-4 on page 1-8 of the application note *Actel eX, SX-A, and RTSX-S I/Os*. Just slightly before  $V_{CCA}$  reaches 2.5 V, the resistors are disabled, so the I/Os will be controlled by user logic. See Table 1-2 on page 1-8 and Table 1-3 on page 1-8 for more information concerning available I/O features.

## PCI Compliance for the SX-A Family

The SX-A family supports 3.3 V and 5 V PCI and is compliant with the PCI Local Bus Specification Rev. 2.1.

Table 2-7 • DC Specifications (5 V PCI Operation)

Symbol	Parameter	Condition	Min.	Max.	Units
$V_{CCA}$	Supply Voltage for Array		2.25	2.75	V
$V_{CCI}$	Supply Voltage for I/Os		4.75	5.25	V
$V_{IH}$	Input High Voltage		2.0	5.75	V
$V_{IL}$	Input Low Voltage		-0.5	0.8	V
$I_{IH}$	Input High Leakage Current <sup>1</sup>	$V_{IN} = 2.7$	-	70	$\mu A$
$I_{IL}$	Input Low Leakage Current <sup>1</sup>	$V_{IN} = 0.5$	-	-70	$\mu A$
$V_{OH}$	Output High Voltage	$I_{OUT} = -2 \text{ mA}$	2.4	-	V
$V_{OL}$	Output Low Voltage <sup>2</sup>	$I_{OUT} = 3 \text{ mA}, 6 \text{ mA}$	-	0.55	V
$C_{IN}$	Input Pin Capacitance <sup>3</sup>		-	10	pF
$C_{CLK}$	CLK Pin Capacitance		5	12	pF

**Notes:**

1. Input leakage currents include hi-Z output leakage for all bidirectional buffers with tristate outputs.
2. Signals without pull-up resistors must have 3 mA low output current. Signals requiring pull-up must have 6 mA; the latter includes FRAME#, IRDY#, TRDY#, DEVSEL#, STOP#, SERR#, PERR#, LOCK#, and, when used AD[63::32], C/BE[7::4]#, PAR64, REQ64#, and ACK64#.
3. Absolute maximum pin capacitance for a PCI input is 10 pF (except for CLK).

Figure 2-1 shows the 5 V PCI V/I curve and the minimum and maximum PCI drive characteristics of the SX-A family.

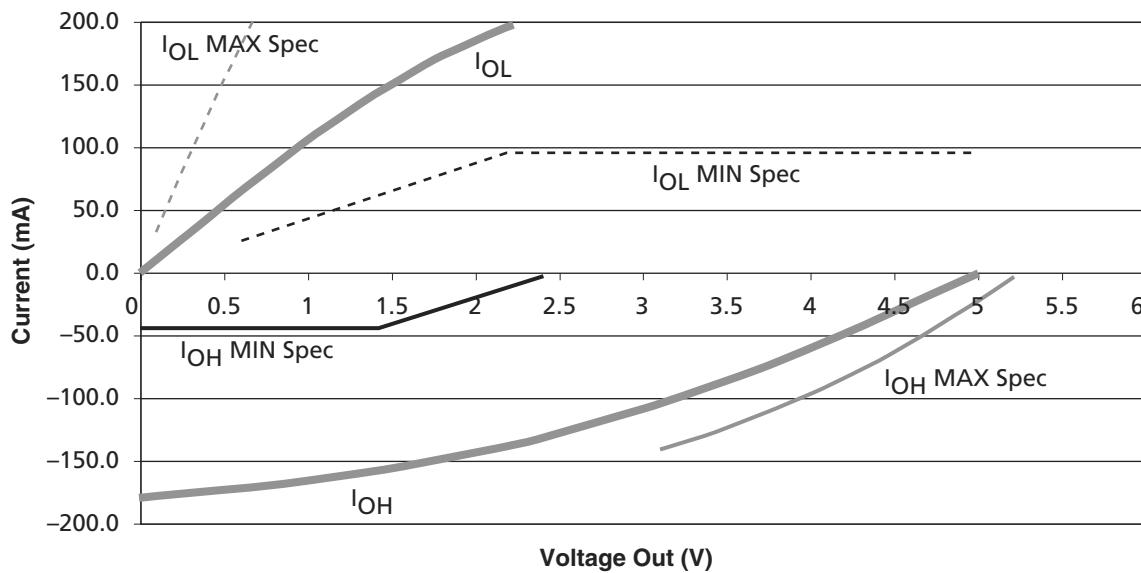


Figure 2-1 • 5 V PCI V/I Curve for SX-A Family

$$I_{OH} = 11.9 * (V_{OUT} - 5.25) * (V_{OUT} + 2.45)$$

for  $V_{CCI} > V_{OUT} > 3.1V$

EQ 2-1

$$I_{OL} = 78.5 * V_{OUT} * (4.4 - V_{OUT})$$

for  $0V < V_{OUT} < 0.71V$

EQ 2-2

Table 2-9 • DC Specifications (3.3 V PCI Operation)

Symbol	Parameter	Condition	Min.	Max.	Units
$V_{CCA}$	Supply Voltage for Array		2.25	2.75	V
$V_{CCI}$	Supply Voltage for I/Os		3.0	3.6	V
$V_{IH}$	Input High Voltage		$0.5V_{CCI}$	$V_{CCI} + 0.5$	V
$V_{IL}$	Input Low Voltage		-0.5	$0.3V_{CCI}$	V
$I_{IPU}$	Input Pull-up Voltage <sup>1</sup>		$0.7V_{CCI}$	-	V
$I_{IL}$	Input Leakage Current <sup>2</sup>	$0 < V_{IN} < V_{CCI}$	-10	+10	$\mu A$
$V_{OH}$	Output High Voltage	$I_{OUT} = -500 \mu A$	$0.9V_{CCI}$	-	V
$V_{OL}$	Output Low Voltage	$I_{OUT} = 1,500 \mu A$		$0.1V_{CCI}$	V
$C_{IN}$	Input Pin Capacitance <sup>3</sup>		-	10	pF
$C_{CLK}$	CLK Pin Capacitance		5	12	pF

#### Notes:

1. This specification should be guaranteed by design. It is the minimum voltage to which pull-up resistors are calculated to pull a floated network. Designers should ensure that the input buffer is conducting minimum current at this input voltage in applications sensitive to static power utilization.
2. Input leakage currents include hi-Z output leakage for all bidirectional buffers with tristate outputs.
3. Absolute maximum pin capacitance for a PCI input is 10 pF (except for CLK).

Figure 2-2 shows the 3.3 V PCI V/I curve and the minimum and maximum PCI drive characteristics of the SX-A family.

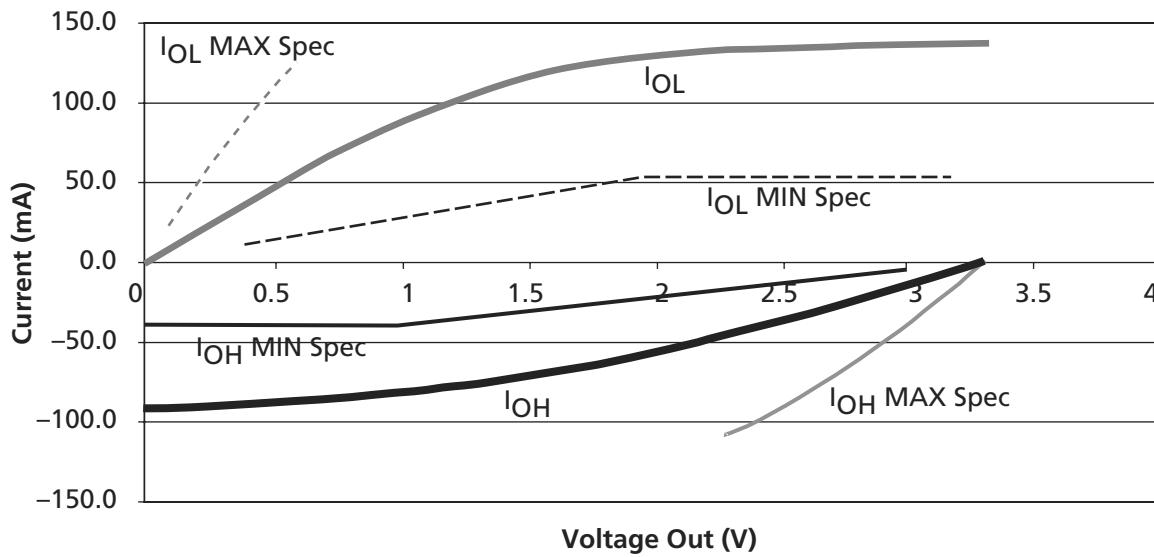


Figure 2-2 • 3.3 V PCI V/I Curve for SX-A Family

$$I_{OH} = (98.0V_{CCI}) * (V_{OUT} - V_{CCI}) * (V_{OUT} + 0.4V_{CCI})$$

for  $0.7V_{CCI} < V_{OUT} < V_{CCI}$

EQ 2-3

$$I_{OL} = (256V_{CCI}) * V_{OUT} * (V_{CCI} - V_{OUT})$$

for  $0V < V_{OUT} < 0.18V_{CCI}$

EQ 2-4

## Power Dissipation

A critical element of system reliability is the ability of electronic devices to safely dissipate the heat generated during operation. The thermal characteristics of a circuit depend on the device and package used, the operating temperature, the operating current, and the system's ability to dissipate heat.

A complete power evaluation should be performed early in the design process to help identify potential heat-related problems in the system and to prevent the system from exceeding the device's maximum allowed junction temperature.

The actual power dissipated by most applications is significantly lower than the power the package can dissipate. However, a thermal analysis should be performed for all projects. To perform a power evaluation, follow these steps:

1. Estimate the power consumption of the application.
2. Calculate the maximum power allowed for the device and package.
3. Compare the estimated power and maximum power values.

### Estimating Power Dissipation

The total power dissipation for the SX-A family is the sum of the DC power dissipation and the AC power dissipation:

$$P_{\text{Total}} = P_{\text{DC}} + P_{\text{AC}}$$

*EQ 2-5*

### DC Power Dissipation

The power due to standby current is typically a small component of the overall power. An estimation of DC power dissipation under typical conditions is given by:

$$P_{\text{DC}} = I_{\text{Standby}} * V_{\text{CCA}}$$

*EQ 2-6*

Note: For other combinations of temperature and voltage settings, refer to the *eX, SX-A and RT54SX-S Power Calculator*.

### AC Power Dissipation

The power dissipation of the SX-A family is usually dominated by the dynamic power dissipation. Dynamic power dissipation is a function of frequency, equivalent capacitance, and power supply voltage. The AC power dissipation is defined as follows:

$$P_{\text{AC}} = P_{\text{C-cells}} + P_{\text{R-cells}} + P_{\text{CLKA}} + P_{\text{CLKB}} + P_{\text{HCLK}} + P_{\text{Output Buffer}} + P_{\text{Input Buffer}}$$

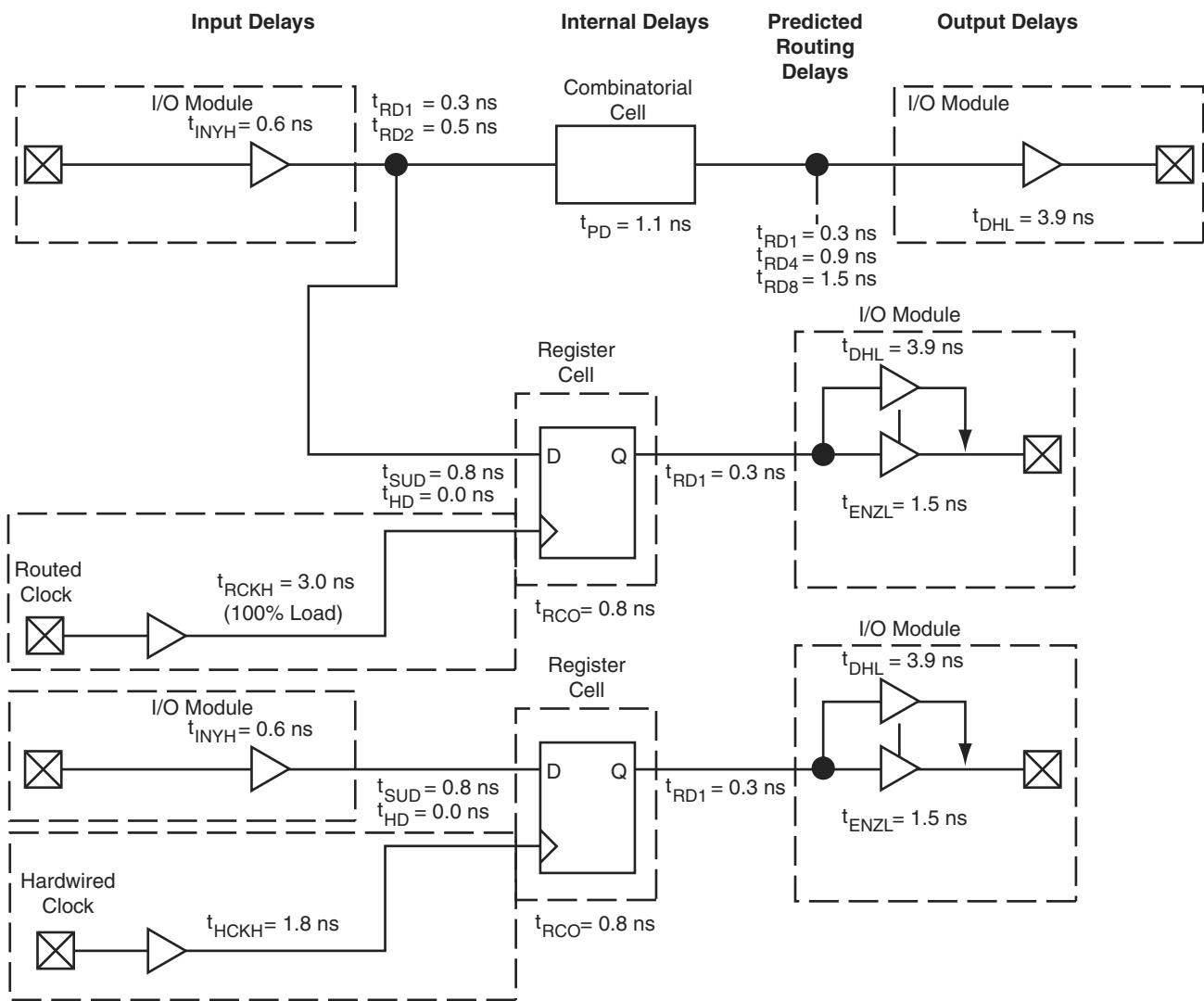
*EQ 2-7*

or:

$$\begin{aligned} P_{\text{AC}} = & V_{\text{CCA}}^2 * [(m * C_{\text{EQCM}} * f_m)_{\text{C-cells}} + (m * C_{\text{EQSM}} * f_m)_{\text{R-cells}} + (n * C_{\text{EQI}} * f_n)_{\text{Input Buffer}} + (p * (C_{\text{EQO}} + C_L) * f_p)_{\text{Output Buffer}} \\ & + (0.5 * (q_1 * C_{\text{EQCR}} * f_{q1}) + (r_1 * f_{q1}))_{\text{CLKA}} + (0.5 * (q_2 * C_{\text{EQCR}} * f_{q2}) + (r_2 * f_{q2}))_{\text{CLKB}} + (0.5 * (s_1 * C_{\text{EQHV}} * f_{s1}) + \\ & (C_{\text{EQHF}} * f_{s1}))_{\text{HCLK}}] \end{aligned}$$

*EQ 2-8*

## SX-A Timing Model



**Note:** \*Values shown for A54SX72A, -2, worst-case commercial conditions at 5 V PCI with standard place-and-route.

Figure 2-3 • SX-A Timing Model

## Sample Path Calculations

### Hardwired Clock

$$\begin{aligned}
 \text{External Setup} &= (t_{INYH} + t_{RD1} + t_{SUD}) - t_{HCKH} \\
 &= 0.6 + 0.3 + 0.8 - 1.8 = -0.1 \text{ ns} \\
 \text{Clock-to-Out (Pad-to-Pad)} &= t_{HCKH} + t_{RCO} + t_{RD1} + t_{DHL} \\
 &= 1.8 + 0.8 + 0.3 + 3.9 = 6.8 \text{ ns}
 \end{aligned}$$

### Routed Clock

$$\begin{aligned}
 \text{External Setup} &= (t_{INYH} + t_{RD1} + t_{SUD}) - t_{RCKH} \\
 &= 0.6 + 0.3 + 0.8 - 3.0 = -1.3 \text{ ns} \\
 \text{Clock-to-Out (Pad-to-Pad)} &= t_{RCKH} + t_{RCO} + t_{RD1} + t_{DHL} \\
 &= 3.0 + 0.8 + 0.3 + 3.9 = 8.0 \text{ ns}
 \end{aligned}$$

Table 2-14 • A54SX08A Timing Characteristics (Continued)  
 (Worst-Case Commercial Conditions,  $V_{CCA} = 2.25\text{ V}$ ,  $V_{CCI} = 3.0\text{ V}$ ,  $T_J = 70^\circ\text{C}$ )

<b>Parameter</b>	<b>Description</b>	<b>-2 Speed</b>	<b>-1 Speed</b>	<b>Std. Speed</b>	<b>-F Speed</b>	<b>Units</b>
		<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	
$t_{INYH}$	Input Data Pad to Y High 5 V PCI	0.5	0.6	0.7	0.9	ns
$t_{INYL}$	Input Data Pad to Y Low 5 V PCI	0.8	0.9	1.1	1.5	ns
$t_{INYH}$	Input Data Pad to Y High 5 V TTL	0.5	0.6	0.7	0.9	ns
$t_{INYL}$	Input Data Pad to Y Low 5 V TTL	0.8	0.9	1.1	1.5	ns
<b>Input Module Predicted Routing Delays<sup>2</sup></b>						
$t_{IRD1}$	FO = 1 Routing Delay	0.3	0.3	0.4	0.6	ns
$t_{IRD2}$	FO = 2 Routing Delay	0.5	0.5	0.6	0.8	ns
$t_{IRD3}$	FO = 3 Routing Delay	0.6	0.7	0.8	1.1	ns
$t_{IRD4}$	FO = 4 Routing Delay	0.8	0.9	1	1.4	ns
$t_{IRD8}$	FO = 8 Routing Delay	1.4	1.5	1.8	2.5	ns
$t_{IRD12}$	FO = 12 Routing Delay	2	2.2	2.6	3.6	ns

**Notes:**

1. For dual-module macros, use  $t_{PD} + t_{RD1} + t_{PDn}$ ,  $t_{RCO} + t_{RD1} + t_{PDn}$ , or  $t_{PD1} + t_{RD1} + t_{SUD}$ , whichever is appropriate.
2. Routing delays are for typical designs across worst-case operating conditions. These parameters should be used for estimating device performance. Post-route timing analysis or simulation is required to determine actual performance.

Table 2-35 • A54SX72A Timing Characteristics  
 (Worst-Case Commercial Conditions,  $V_{CCA} = 2.25\text{ V}$ ,  $V_{CCI} = 3.0\text{ V}$ ,  $T_J = 70^\circ\text{C}$ )

<b>Parameter</b>	<b>Description</b>	<b>-3 Speed<sup>1</sup></b>	<b>-2 Speed</b>	<b>-1 Speed</b>	<b>Std. Speed</b>	<b>-F Speed</b>	<b>Units</b>
		<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	
<b>C-Cell Propagation Delays<sup>2</sup></b>							
$t_{PD}$	Internal Array Module	1.0	1.1	1.3	1.5	2.0	ns
<b>Predicted Routing Delays<sup>3</sup></b>							
$t_{DC}$	FO = 1 Routing Delay, Direct Connect	0.1	0.1	0.1	0.1	0.1	ns
$t_{FC}$	FO = 1 Routing Delay, Fast Connect	0.3	0.3	0.3	0.4	0.6	ns
$t_{RD1}$	FO = 1 Routing Delay	0.3	0.3	0.4	0.5	0.7	ns
$t_{RD2}$	FO = 2 Routing Delay	0.4	0.5	0.6	0.7	1	ns
$t_{RD3}$	FO = 3 Routing Delay	0.5	0.7	0.8	0.9	1.3	ns
$t_{RD4}$	FO = 4 Routing Delay	0.7	0.9	1	1.1	1.5	ns
$t_{RD8}$	FO = 8 Routing Delay	1.2	1.5	1.7	2.1	2.9	ns
$t_{RD12}$	FO = 12 Routing Delay	1.7	2.2	2.5	3	4.2	ns
<b>R-Cell Timing</b>							
$t_{RCO}$	Sequential Clock-to-Q	0.7	0.8	0.9	1.1	1.5	ns
$t_{CLR}$	Asynchronous Clear-to-Q	0.6	0.7	0.7	0.9	1.2	ns
$t_{PRESET}$	Asynchronous Preset-to-Q	0.7	0.8	0.8	1.0	1.4	ns
$t_{SUD}$	Flip-Flop Data Input Set-Up	0.7	0.8	0.9	1.0	1.4	ns
$t_{HD}$	Flip-Flop Data Input Hold	0.0	0.0	0.0	0.0	0.0	ns
$t_{WASYN}$	Asynchronous Pulse Width	1.3	1.5	1.7	2.0	2.8	ns
$t_{RECASYN}$	Asynchronous Recovery Time	0.3	0.4	0.4	0.5	0.7	ns
$t_{HASYN}$	Asynchronous Hold Time	0.3	0.3	0.3	0.4	0.6	ns
$t_{MPW}$	Clock Minimum Pulse Width	1.5	1.7	2.0	2.3	3.2	ns
<b>Input Module Propagation Delays</b>							
$t_{INYH}$	Input Data Pad to Y High 2.5 V LVC MOS	0.6	0.7	0.8	0.9	1.3	ns
$t_{INYL}$	Input Data Pad to Y Low 2.5 V LVC MOS	0.8	1.0	1.1	1.3	1.7	ns
$t_{INYH}$	Input Data Pad to Y High 3.3 V PCI	0.6	0.7	0.7	0.9	1.2	ns
$t_{INYL}$	Input Data Pad to Y Low 3.3 V PCI	0.7	0.8	0.9	1.0	1.4	ns
$t_{INYH}$	Input Data Pad to Y High 3.3 V LV TTL	0.7	0.7	0.8	1.0	1.4	ns
$t_{INYL}$	Input Data Pad to Y Low 3.3 V LV TTL	1.0	1.2	1.3	1.5	2.1	ns

**Notes:**

1. All -3 speed grades have been discontinued.
2. For dual-module macros, use  $t_{PD} + t_{RD1} + t_{PDn}$ ,  $t_{RCO} + t_{RD1} + t_{PDn}$ , or  $t_{PD1} + t_{RD1} + t_{SUD}$ , whichever is appropriate.
3. Routing delays are for typical designs across worst-case operating conditions. These parameters should be used for estimating device performance. Post-route timing analysis or simulation is required to determine actual performance.

Table 2-38 • A54SX72A Timing Characteristics (Continued)  
 (Worst-Case Commercial Conditions  $V_{CCA} = 2.25\text{ V}$ ,  $V_{CCI} = 4.75\text{ V}$ ,  $T_J = 70^\circ\text{C}$ )

<b>Parameter</b>	<b>Description</b>	<b>-3 Speed*</b>	<b>-2 Speed</b>	<b>-1 Speed</b>	<b>Std. Speed</b>	<b>-F Speed</b>	<b>Units</b>
		<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	
$t_{QCKH}$	Input Low to High (100% Load) (Pad to R-cell Input)	1.6	1.8	2.1	2.4	3.4	ns
$t_{QCHKL}$	Input High to Low (100% Load) (Pad to R-cell Input)	1.6	1.9	2.1	2.5	3.5	ns
$t_{QPWH}$	Minimum Pulse Width High	1.5	1.7	2.0	2.3	3.2	ns
$t_{QPWL}$	Minimum Pulse Width Low	1.5	1.7	2.0	2.3	3.2	ns
$t_{QCKSW}$	Maximum Skew (Light Load)	0.2	0.3	0.3	0.3	0.5	ns
$t_{QCKSW}$	Maximum Skew (50% Load)	0.4	0.5	0.5	0.6	0.9	ns
$t_{QCKSW}$	Maximum Skew (100% Load)	0.4	0.5	0.5	0.6	0.9	ns

**Note:** \*All -3 speed grades have been discontinued.

Table 2-40 • A54SX72A Timing Characteristics  
 (Worst-Case Commercial Conditions  $V_{CCA} = 2.25\text{ V}$ ,  $V_{CCI} = 3.0\text{ V}$ ,  $T_J = 70^\circ\text{C}$ )

<b>Parameter</b>	<b>Description</b>	<b>-3 Speed<sup>1</sup></b>	<b>-2 Speed</b>	<b>-1 Speed</b>	<b>Std. Speed</b>	<b>-F Speed</b>	<b>Units</b>
		<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	<b>Max.</b>	<b>Min.</b>	
<b>3.3 V PCI Output Module Timing<sup>2</sup></b>							
$t_{DLH}$	Data-to-Pad Low to High	2.3	2.7	3.0	3.6	5.0	ns
$t_{DHL}$	Data-to-Pad High to Low	2.5	2.9	3.2	3.8	5.3	ns
$t_{ENZL}$	Enable-to-Pad, Z to L	1.4	1.7	1.9	2.2	3.1	ns
$t_{ENZH}$	Enable-to-Pad, Z to H	2.3	2.7	3.0	3.6	5.0	ns
$t_{ENLZ}$	Enable-to-Pad, L to Z	2.5	2.8	3.2	3.8	5.3	ns
$t_{ENHZ}$	Enable-to-Pad, H to Z	2.5	2.9	3.2	3.8	5.3	ns
$d_{TLH}^3$	Delta Low to High	0.025	0.03	0.03	0.04	0.045	ns/pF
$d_{THL}^3$	Delta High to Low	0.015	0.015	0.015	0.015	0.025	ns/pF
<b>3.3 V LVTTL Output Module Timing<sup>4</sup></b>							
$t_{DLH}$	Data-to-Pad Low to High	3.2	3.7	4.2	5.0	6.9	ns
$t_{DHL}$	Data-to-Pad High to Low	3.2	3.7	4.2	4.9	6.9	ns
$t_{DHLS}$	Data-to-Pad High to Low—low slew	10.3	11.9	13.5	15.8	22.2	ns
$t_{ENZL}$	Enable-to-Pad, Z to L	2.2	2.6	2.9	3.4	4.8	ns
$t_{ENZLS}$	Enable-to-Pad, Z to L—low slew	15.8	18.9	21.3	25.4	34.9	ns
$t_{ENZH}$	Enable-to-Pad, Z to H	3.2	3.7	4.2	5.0	6.9	ns
$t_{ENLZ}$	Enable-to-Pad, L to Z	2.9	3.3	3.7	4.4	6.2	ns
$t_{ENHZ}$	Enable-to-Pad, H to Z	3.2	3.7	4.2	4.9	6.9	ns
$d_{TLH}^3$	Delta Low to High	0.025	0.03	0.03	0.04	0.045	ns/pF
$d_{THL}^3$	Delta High to Low	0.015	0.015	0.015	0.015	0.025	ns/pF
$d_{THLS}^3$	Delta High to Low—low slew	0.053	0.053	0.067	0.073	0.107	ns/pF

**Notes:**

1. All -3 speed grades have been discontinued.
2. Delays based on 10 pF loading and 25  $\Omega$  resistance.
3. To obtain the slew rate, substitute the appropriate Delta value, load capacitance, and the  $V_{CCI}$  value into the following equation:  

$$\text{Slew Rate [V/ns]} = (0.1 * V_{CCI} - 0.9 * V_{CCI}) / (C_{load} * d_{T[LH|HL|HLS]})$$
 where  $C_{load}$  is the load capacitance driven by the I/O in pF  
 $d_{T[LH|HL|HLS]}$  is the worst case delta value from the datasheet in ns/pF.
4. Delays based on 35 pF loading.

<b>208-Pin PQFP</b>				
<b>Pin Number</b>	<b>A54SX08A Function</b>	<b>A54SX16A Function</b>	<b>A54SX32A Function</b>	<b>A54SX72A Function</b>
71	I/O	I/O	I/O	I/O
72	I/O	I/O	I/O	I/O
73	NC	I/O	I/O	I/O
74	I/O	I/O	I/O	QCLKA
75	NC	I/O	I/O	I/O
76	PRB, I/O	PRB, I/O	PRB, I/O	PRB, I/O
77	GND	GND	GND	GND
78	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>
79	GND	GND	GND	GND
80	NC	NC	NC	NC
81	I/O	I/O	I/O	I/O
82	HCLK	HCLK	HCLK	HCLK
83	I/O	I/O	I/O	V <sub>CCI</sub>
84	I/O	I/O	I/O	QCLKB
85	NC	I/O	I/O	I/O
86	I/O	I/O	I/O	I/O
87	I/O	I/O	I/O	I/O
88	NC	I/O	I/O	I/O
89	I/O	I/O	I/O	I/O
90	I/O	I/O	I/O	I/O
91	NC	I/O	I/O	I/O
92	I/O	I/O	I/O	I/O
93	I/O	I/O	I/O	I/O
94	NC	I/O	I/O	I/O
95	I/O	I/O	I/O	I/O
96	I/O	I/O	I/O	I/O
97	NC	I/O	I/O	I/O
98	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
99	I/O	I/O	I/O	I/O
100	I/O	I/O	I/O	I/O
101	I/O	I/O	I/O	I/O
102	I/O	I/O	I/O	I/O
103	TDO, I/O	TDO, I/O	TDO, I/O	TDO, I/O
104	I/O	I/O	I/O	I/O
105	GND	GND	GND	GND

<b>208-Pin PQFP</b>				
<b>Pin Number</b>	<b>A54SX08A Function</b>	<b>A54SX16A Function</b>	<b>A54SX32A Function</b>	<b>A54SX72A Function</b>
106	NC	I/O	I/O	I/O
107	I/O	I/O	I/O	I/O
108	NC	I/O	I/O	I/O
109	I/O	I/O	I/O	I/O
110	I/O	I/O	I/O	I/O
111	I/O	I/O	I/O	I/O
112	I/O	I/O	I/O	I/O
113	I/O	I/O	I/O	I/O
114	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>
115	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
116	NC	I/O	I/O	GND
117	I/O	I/O	I/O	V <sub>CCA</sub>
118	I/O	I/O	I/O	I/O
119	NC	I/O	I/O	I/O
120	I/O	I/O	I/O	I/O
121	I/O	I/O	I/O	I/O
122	NC	I/O	I/O	I/O
123	I/O	I/O	I/O	I/O
124	I/O	I/O	I/O	I/O
125	NC	I/O	I/O	I/O
126	I/O	I/O	I/O	I/O
127	I/O	I/O	I/O	I/O
128	I/O	I/O	I/O	I/O
129	GND	GND	GND	GND
130	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>
131	GND	GND	GND	GND
132	NC	NC	NC	I/O
133	I/O	I/O	I/O	I/O
134	I/O	I/O	I/O	I/O
135	NC	I/O	I/O	I/O
136	I/O	I/O	I/O	I/O
137	I/O	I/O	I/O	I/O
138	NC	I/O	I/O	I/O
139	I/O	I/O	I/O	I/O
140	I/O	I/O	I/O	I/O

<b>208-Pin PQFP</b>				
<b>Pin Number</b>	<b>A54SX08A Function</b>	<b>A54SX16A Function</b>	<b>A54SX32A Function</b>	<b>A54SX72A Function</b>
141	NC	I/O	I/O	I/O
142	I/O	I/O	I/O	I/O
143	NC	I/O	I/O	I/O
144	I/O	I/O	I/O	I/O
145	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>
146	GND	GND	GND	GND
147	I/O	I/O	I/O	I/O
148	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
149	I/O	I/O	I/O	I/O
150	I/O	I/O	I/O	I/O
151	I/O	I/O	I/O	I/O
152	I/O	I/O	I/O	I/O
153	I/O	I/O	I/O	I/O
154	I/O	I/O	I/O	I/O
155	NC	I/O	I/O	I/O
156	NC	I/O	I/O	I/O
157	GND	GND	GND	GND
158	I/O	I/O	I/O	I/O
159	I/O	I/O	I/O	I/O
160	I/O	I/O	I/O	I/O
161	I/O	I/O	I/O	I/O
162	I/O	I/O	I/O	I/O
163	I/O	I/O	I/O	I/O
164	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
165	I/O	I/O	I/O	I/O
166	I/O	I/O	I/O	I/O
167	NC	I/O	I/O	I/O
168	I/O	I/O	I/O	I/O
169	I/O	I/O	I/O	I/O
170	NC	I/O	I/O	I/O
171	I/O	I/O	I/O	I/O
172	I/O	I/O	I/O	I/O
173	NC	I/O	I/O	I/O
174	I/O	I/O	I/O	I/O
175	I/O	I/O	I/O	I/O

<b>208-Pin PQFP</b>				
<b>Pin Number</b>	<b>A54SX08A Function</b>	<b>A54SX16A Function</b>	<b>A54SX32A Function</b>	<b>A54SX72A Function</b>
176	NC	I/O	I/O	I/O
177	I/O	I/O	I/O	I/O
178	I/O	I/O	I/O	QCLKD
179	I/O	I/O	I/O	I/O
180	CLKA	CLKA	CLKA	CLKA
181	CLKB	CLKB	CLKB	CLKB
182	NC	NC	NC	NC
183	GND	GND	GND	GND
184	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>
185	GND	GND	GND	GND
186	PRA, I/O	PRA, I/O	PRA, I/O	PRA, I/O
187	I/O	I/O	I/O	V <sub>CCI</sub>
188	I/O	I/O	I/O	I/O
189	NC	I/O	I/O	I/O
190	I/O	I/O	I/O	QCLKC
191	I/O	I/O	I/O	I/O
192	NC	I/O	I/O	I/O
193	I/O	I/O	I/O	I/O
194	I/O	I/O	I/O	I/O
195	NC	I/O	I/O	I/O
196	I/O	I/O	I/O	I/O
197	I/O	I/O	I/O	I/O
198	NC	I/O	I/O	I/O
199	I/O	I/O	I/O	I/O
200	I/O	I/O	I/O	I/O
201	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
202	NC	I/O	I/O	I/O
203	NC	I/O	I/O	I/O
204	I/O	I/O	I/O	I/O
205	NC	I/O	I/O	I/O
206	I/O	I/O	I/O	I/O
207	I/O	I/O	I/O	I/O
208	TCK, I/O	TCK, I/O	TCK, I/O	TCK, I/O

<b>144-Pin TQFP</b>			
<b>Pin Number</b>	<b>A54SX08A Function</b>	<b>A54SX16A Function</b>	<b>A54SX32A Function</b>
1	GND	GND	GND
2	TDI, I/O	TDI, I/O	TDI, I/O
3	I/O	I/O	I/O
4	I/O	I/O	I/O
5	I/O	I/O	I/O
6	I/O	I/O	I/O
7	I/O	I/O	I/O
8	I/O	I/O	I/O
9	TMS	TMS	TMS
10	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
11	GND	GND	GND
12	I/O	I/O	I/O
13	I/O	I/O	I/O
14	I/O	I/O	I/O
15	I/O	I/O	I/O
16	I/O	I/O	I/O
17	I/O	I/O	I/O
18	I/O	I/O	I/O
19	NC	NC	NC
20	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>
21	I/O	I/O	I/O
22	TRST, I/O	TRST, I/O	TRST, I/O
23	I/O	I/O	I/O
24	I/O	I/O	I/O
25	I/O	I/O	I/O
26	I/O	I/O	I/O
27	I/O	I/O	I/O
28	GND	GND	GND
29	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
30	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>
31	I/O	I/O	I/O
32	I/O	I/O	I/O
33	I/O	I/O	I/O
34	I/O	I/O	I/O
35	I/O	I/O	I/O
36	GND	GND	GND
37	I/O	I/O	I/O

<b>144-Pin TQFP</b>			
<b>Pin Number</b>	<b>A54SX08A Function</b>	<b>A54SX16A Function</b>	<b>A54SX32A Function</b>
38	I/O	I/O	I/O
39	I/O	I/O	I/O
40	I/O	I/O	I/O
41	I/O	I/O	I/O
42	I/O	I/O	I/O
43	I/O	I/O	I/O
44	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
45	I/O	I/O	I/O
46	I/O	I/O	I/O
47	I/O	I/O	I/O
48	I/O	I/O	I/O
49	I/O	I/O	I/O
50	I/O	I/O	I/O
51	I/O	I/O	I/O
52	I/O	I/O	I/O
53	I/O	I/O	I/O
54	PRB, I/O	PRB, I/O	PRB, I/O
55	I/O	I/O	I/O
56	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>
57	GND	GND	GND
58	NC	NC	NC
59	I/O	I/O	I/O
60	HCLK	HCLK	HCLK
61	I/O	I/O	I/O
62	I/O	I/O	I/O
63	I/O	I/O	I/O
64	I/O	I/O	I/O
65	I/O	I/O	I/O
66	I/O	I/O	I/O
67	I/O	I/O	I/O
68	V <sub>CCI</sub>	V <sub>CCI</sub>	V <sub>CCI</sub>
69	I/O	I/O	I/O
70	I/O	I/O	I/O
71	TDO, I/O	TDO, I/O	TDO, I/O
72	I/O	I/O	I/O
73	GND	GND	GND
74	I/O	I/O	I/O

## 176-Pin TQFP

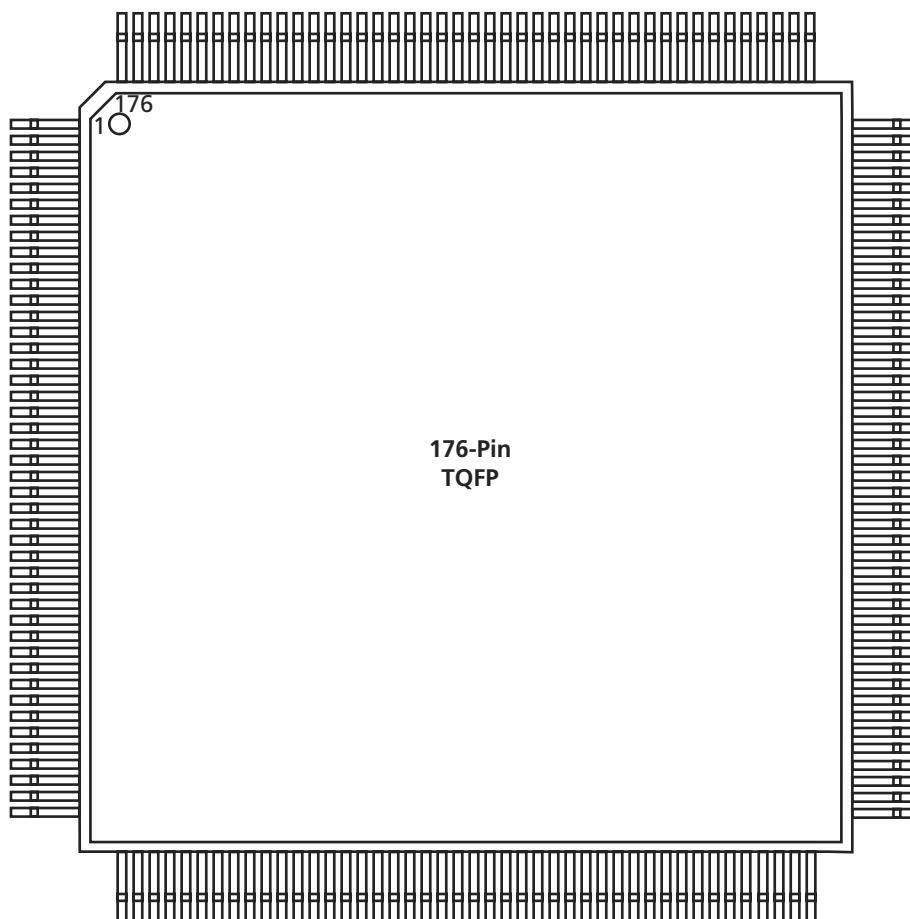


Figure 3-4 • 176-Pin TQFP (Top View)

### Note

For Package Manufacturing and Environmental information, visit Resource center at  
<http://www.actel.com/products/rescenter/package/index.html>.

329-Pin PBGA	
Pin Number	A54SX32A Function
A1	GND
A2	GND
A3	V <sub>CCI</sub>
A4	NC
A5	I/O
A6	I/O
A7	V <sub>CCI</sub>
A8	NC
A9	I/O
A10	I/O
A11	I/O
A12	I/O
A13	CLKB
A14	I/O
A15	I/O
A16	I/O
A17	I/O
A18	I/O
A19	I/O
A20	I/O
A21	NC
A22	V <sub>CCI</sub>
A23	GND
AA1	V <sub>CCI</sub>
AA2	I/O
AA3	GND
AA4	I/O
AA5	I/O
AA6	I/O
AA7	I/O
AA8	I/O
AA9	I/O
AA10	I/O
AA11	I/O
AA12	I/O
AA13	I/O
AA14	I/O

329-Pin PBGA	
Pin Number	A54SX32A Function
AA15	I/O
AA16	I/O
AA17	I/O
AA18	I/O
AA19	I/O
AA20	TDO, I/O
AA21	V <sub>CCI</sub>
AA22	I/O
AA23	V <sub>CCI</sub>
AB1	I/O
AB2	GND
AB3	I/O
AB4	I/O
AB5	I/O
AB6	I/O
AB7	I/O
AB8	I/O
AB9	I/O
AB10	I/O
AB11	PRB, I/O
AB12	I/O
AB13	HCLK
AB14	I/O
AB15	I/O
AB16	I/O
AB17	I/O
AB18	I/O
AB19	I/O
AB20	I/O
AB21	I/O
AB22	GND
AB23	I/O
AC1	GND
AC2	V <sub>CCI</sub>
AC3	NC
AC4	I/O
AC5	I/O

329-Pin PBGA	
Pin Number	A54SX32A Function
AC6	I/O
AC7	I/O
AC8	I/O
AC9	V <sub>CCI</sub>
AC10	I/O
AC11	I/O
AC12	I/O
AC13	I/O
AC14	I/O
AC15	NC
AC16	I/O
AC17	I/O
AC18	I/O
AC19	I/O
AC20	I/O
AC21	NC
AC22	V <sub>CCI</sub>
AC23	GND
B1	V <sub>CCI</sub>
B2	GND
B3	I/O
B4	I/O
B5	I/O
B6	I/O
B7	I/O
B8	I/O
B9	I/O
B10	I/O
B11	I/O
B12	PRA, I/O
B13	CLKA
B14	I/O
B15	I/O
B16	I/O
B17	I/O
B18	I/O
B19	I/O

329-Pin PBGA	
Pin Number	A54SX32A Function
B20	I/O
B21	I/O
B22	GND
B23	V <sub>CCI</sub>
C1	NC
C2	TDI, I/O
C3	GND
C4	I/O
C5	I/O
C6	I/O
C7	I/O
C8	I/O
C9	I/O
C10	I/O
C11	I/O
C12	I/O
C13	I/O
C14	I/O
C15	I/O
C16	I/O
C17	I/O
C18	I/O
C19	I/O
C20	I/O
C21	V <sub>CCI</sub>
C22	GND
C23	NC
D1	I/O
D2	I/O
D3	I/O
D4	TCK, I/O
D5	I/O
D6	I/O
D7	I/O
D8	I/O
D9	I/O
D10	I/O

329-Pin PBGA	
Pin Number	A54SX32A Function
D11	V <sub>CCA</sub>
D12	NC
D13	I/O
D14	I/O
D15	I/O
D16	I/O
D17	I/O
D18	I/O
D19	I/O
D20	I/O
D21	I/O
D22	I/O
D23	I/O
E1	V <sub>CCI</sub>
E2	I/O
E3	I/O
E4	I/O
E20	I/O
E21	I/O
E22	I/O
E23	I/O
F1	I/O
F2	TMS
F3	I/O
F4	I/O
F20	I/O
F21	I/O
F22	I/O
F23	I/O
G1	I/O
G2	I/O
G3	I/O
G4	I/O
G20	I/O
G21	I/O
G22	I/O
G23	GND

329-Pin PBGA	
Pin Number	A54SX32A Function
H1	I/O
H2	I/O
H3	I/O
H4	I/O
H20	V <sub>CCA</sub>
H21	I/O
H22	I/O
H23	I/O
J1	NC
J2	I/O
J3	I/O
J4	I/O
J20	I/O
J21	I/O
J22	I/O
J23	I/O
K1	I/O
K2	I/O
K3	I/O
K4	I/O
K10	GND
K11	GND
K12	GND
K13	GND
K14	GND
K20	I/O
K21	I/O
K22	I/O
K23	I/O
L1	I/O
L2	I/O
L3	I/O
L4	NC
L10	GND
L11	GND
L12	GND
L13	GND

329-Pin PBGA	
Pin Number	A54SX32A Function
L14	GND
L20	NC
L21	I/O
L22	I/O
L23	NC
M1	I/O
M2	I/O
M3	I/O
M4	V <sub>CCA</sub>
M10	GND
M11	GND
M12	GND
M13	GND
M14	GND
M20	V <sub>CCA</sub>
M21	I/O
M22	I/O
M23	V <sub>CCI</sub>
N1	I/O
N2	TRST, I/O
N3	I/O
N4	I/O
N10	GND
N11	GND
N12	GND
N13	GND
N14	GND
N20	NC
N21	I/O
N22	I/O
N23	I/O
P1	I/O
P2	I/O
P3	I/O
P4	I/O
P10	GND
P11	GND

329-Pin PBGA	
Pin Number	A54SX32A Function
P12	GND
P13	GND
P14	GND
P20	I/O
P21	I/O
P22	I/O
P23	I/O
R1	I/O
R2	I/O
R3	I/O
R4	I/O
R20	I/O
R21	I/O
R22	I/O
R23	I/O
T1	I/O
T2	I/O
T3	I/O
T4	I/O
T20	I/O
T21	I/O
T22	I/O
T23	I/O
U1	I/O
U2	I/O
U3	V <sub>CCA</sub>
U4	I/O
U20	I/O
U21	V <sub>CCA</sub>
U22	I/O
U23	I/O
V1	V <sub>CCI</sub>
V2	I/O
V3	I/O
V4	I/O
V20	I/O
V21	I/O

256-Pin FBGA			
Pin Number	A54SX16A Function	A54SX32A Function	A54SX72A Function
A1	GND	GND	GND
A2	TCK, I/O	TCK, I/O	TCK, I/O
A3	I/O	I/O	I/O
A4	I/O	I/O	I/O
A5	I/O	I/O	I/O
A6	I/O	I/O	I/O
A7	I/O	I/O	I/O
A8	I/O	I/O	I/O
A9	CLKB	CLKB	CLKB
A10	I/O	I/O	I/O
A11	I/O	I/O	I/O
A12	NC	I/O	I/O
A13	I/O	I/O	I/O
A14	I/O	I/O	I/O
A15	GND	GND	GND
A16	GND	GND	GND
B1	I/O	I/O	I/O
B2	GND	GND	GND
B3	I/O	I/O	I/O
B4	I/O	I/O	I/O
B5	I/O	I/O	I/O
B6	NC	I/O	I/O
B7	I/O	I/O	I/O
B8	V <sub>CCA</sub>	V <sub>CCA</sub>	V <sub>CCA</sub>
B9	I/O	I/O	I/O
B10	I/O	I/O	I/O
B11	NC	I/O	I/O
B12	I/O	I/O	I/O
B13	I/O	I/O	I/O
B14	I/O	I/O	I/O
B15	GND	GND	GND
B16	I/O	I/O	I/O
C1	I/O	I/O	I/O
C2	TDI, I/O	TDI, I/O	TDI, I/O
C3	GND	GND	GND
C4	I/O	I/O	I/O
C5	NC	I/O	I/O

256-Pin FBGA			
Pin Number	A54SX16A Function	A54SX32A Function	A54SX72A Function
C6	I/O	I/O	I/O
C7	I/O	I/O	I/O
C8	I/O	I/O	I/O
C9	CLKA	CLKA	CLKA
C10	I/O	I/O	I/O
C11	I/O	I/O	I/O
C12	I/O	I/O	I/O
C13	I/O	I/O	I/O
C14	I/O	I/O	I/O
C15	I/O	I/O	I/O
C16	I/O	I/O	I/O
D1	I/O	I/O	I/O
D2	I/O	I/O	I/O
D3	I/O	I/O	I/O
D4	I/O	I/O	I/O
D5	I/O	I/O	I/O
D6	I/O	I/O	I/O
D7	I/O	I/O	I/O
D8	PRA, I/O	PRA, I/O	PRA, I/O
D9	I/O	I/O	QCLKD
D10	I/O	I/O	I/O
D11	NC	I/O	I/O
D12	I/O	I/O	I/O
D13	I/O	I/O	I/O
D14	I/O	I/O	I/O
D15	I/O	I/O	I/O
D16	I/O	I/O	I/O
E1	I/O	I/O	I/O
E2	I/O	I/O	I/O
E3	I/O	I/O	I/O
E4	I/O	I/O	I/O
E5	I/O	I/O	I/O
E6	I/O	I/O	I/O
E7	I/O	I/O	QCLKC
E8	I/O	I/O	I/O
E9	I/O	I/O	I/O
E10	I/O	I/O	I/O

<b>484-Pin FBGA</b>		
<b>Pin Number</b>	<b>A54SX32A Function</b>	<b>A54SX72A Function</b>
K10	GND	GND
K11	GND	GND
K12	GND	GND
K13	GND	GND
K14	GND	GND
K15	GND	GND
K16	GND	GND
K17	GND	GND
K22	I/O	I/O
K23	I/O	I/O
K24	NC*	NC
K25	NC*	I/O
K26	NC*	I/O
L1	NC*	I/O
L2	NC*	I/O
L3	I/O	I/O
L4	I/O	I/O
L5	I/O	I/O
L10	GND	GND
L11	GND	GND
L12	GND	GND
L13	GND	GND
L14	GND	GND
L15	GND	GND
L16	GND	GND
L17	GND	GND
L22	I/O	I/O
L23	I/O	I/O
L24	I/O	I/O
L25	I/O	I/O
L26	I/O	I/O
M1	NC*	NC
M2	I/O	I/O
M3	I/O	I/O
M4	I/O	I/O

<b>484-Pin FBGA</b>		
<b>Pin Number</b>	<b>A54SX32A Function</b>	<b>A54SX72A Function</b>
M5	I/O	I/O
M10	GND	GND
M11	GND	GND
M12	GND	GND
M13	GND	GND
M14	GND	GND
M15	GND	GND
M16	GND	GND
M17	GND	GND
M22	I/O	I/O
M23	I/O	I/O
M24	I/O	I/O
M25	NC*	I/O
M26	NC*	I/O
N1	I/O	I/O
N2	V <sub>CCI</sub>	V <sub>CCI</sub>
N3	I/O	I/O
N4	I/O	I/O
N5	I/O	I/O
N10	GND	GND
N11	GND	GND
N12	GND	GND
N13	GND	GND
N14	GND	GND
N15	GND	GND
N16	GND	GND
N17	GND	GND
N22	V <sub>CCA</sub>	V <sub>CCA</sub>
N23	I/O	I/O
N24	I/O	I/O
N25	I/O	I/O
N26	NC*	NC
P1	NC*	I/O
P2	NC*	I/O
P3	I/O	I/O

<b>484-Pin FBGA</b>		
<b>Pin Number</b>	<b>A54SX32A Function</b>	<b>A54SX72A Function</b>
P4	I/O	I/O
P5	V <sub>CCA</sub>	V <sub>CCA</sub>
P10	GND	GND
P11	GND	GND
P12	GND	GND
P13	GND	GND
P14	GND	GND
P15	GND	GND
P16	GND	GND
P17	GND	GND
P22	I/O	I/O
P23	I/O	I/O
P24	V <sub>CCI</sub>	V <sub>CCI</sub>
P25	I/O	I/O
P26	I/O	I/O
R1	NC*	I/O
R2	NC*	I/O
R3	I/O	I/O
R4	I/O	I/O
R5	TRST, I/O	TRST, I/O
R10	GND	GND
R11	GND	GND
R12	GND	GND
R13	GND	GND
R14	GND	GND
R15	GND	GND
R16	GND	GND
R17	GND	GND
R22	I/O	I/O
R23	I/O	I/O
R24	I/O	I/O
R25	NC*	I/O
R26	NC*	I/O
T1	NC*	I/O
T2	NC*	I/O

**Note:** \*These pins must be left floating on the A54SX32A device.

Actel and the Actel logo are registered trademarks of Actel Corporation.  
All other trademarks are the property of their owners.



[www.actel.com](http://www.actel.com)

**Actel Corporation**

2061 Stierlin Court  
Mountain View, CA  
94043-4655 USA  
**Phone** 650.318.4200  
**Fax** 650.318.4600

**Actel Europe Ltd.**

River Court, Meadows Business Park  
Station Approach, Blackwater  
Camberley, Surrey GU17 9AB  
United Kingdom  
**Phone** +44 (0) 1276 609 300  
**Fax** +44 (0) 1276 607 540

**Actel Japan**

EXOS Ebisu Bldg. 4F  
1-24-14 Ebisu Shibuya-ku  
Tokyo 150 Japan  
**Phone** +81.03.3445.7671  
**Fax** +81.03.3445.7668  
[www.jp.actel.com](http://www.jp.actel.com)

**Actel Hong Kong**

Suite 2114, Two Pacific Place  
88 Queensway, Admiralty  
Hong Kong  
**Phone** +852 2185 6460  
**Fax** +852 2185 6488  
[www.actel.com.cn](http://www.actel.com.cn)